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7542 群

定时器 X 运行（脉冲宽度测定模式）

要点

本资料说明 7542 群的定时器 X 脉冲宽度测定模式功能的设定方法例子和应用例子。

动作确认器件

本资料说明的应用例子适合下列单片机：

- 单片机：7542 群

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1. 设定方法

定时器X（脉冲宽度测定模式）的设定方法如图1和图2所示。

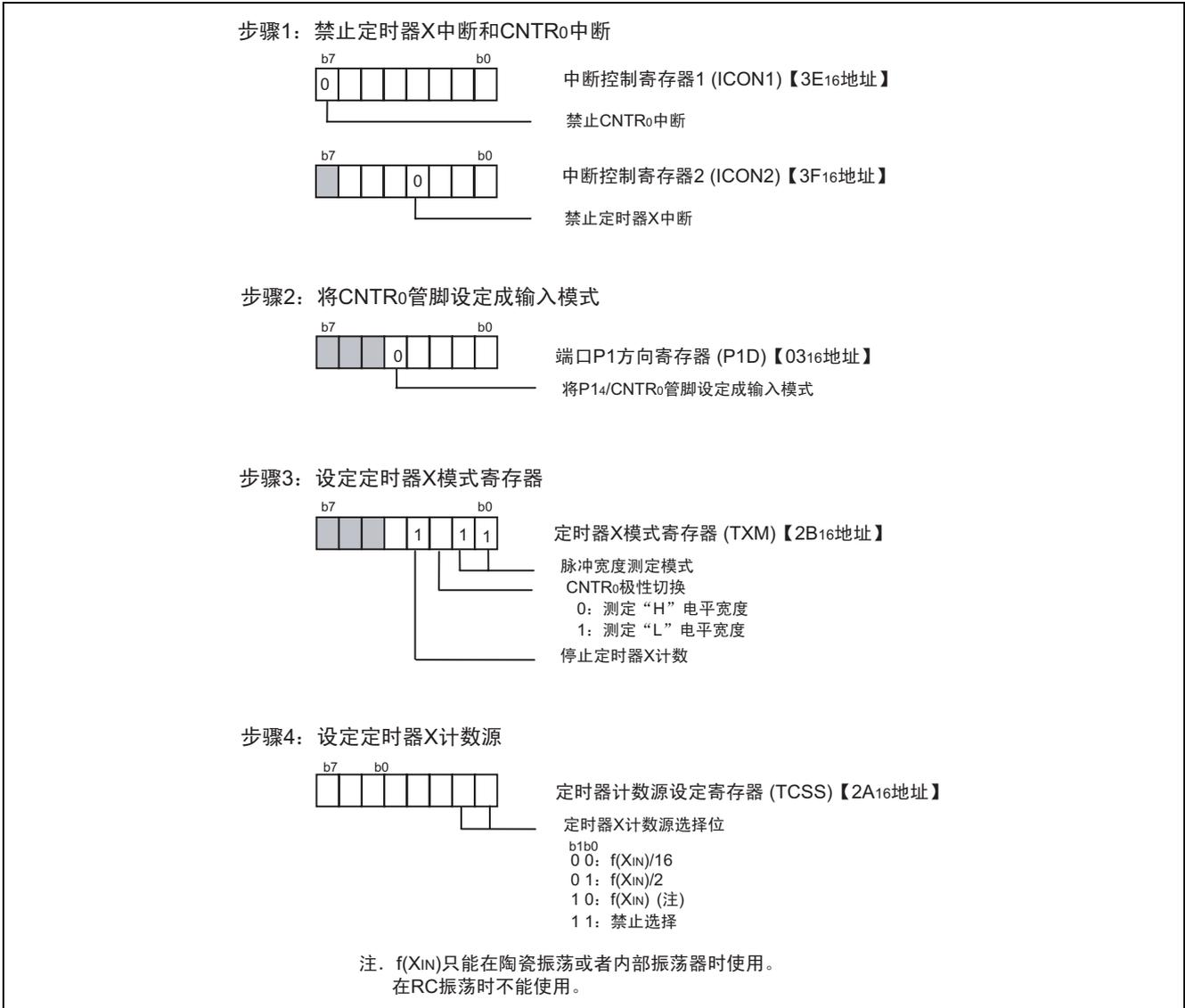


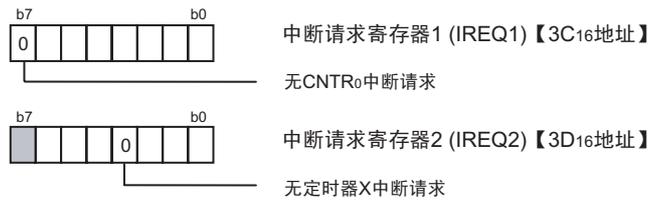
图 1 定时器 X 脉冲宽度测定模式的设定方法（1）

步骤5: 设定定时器X的计数值

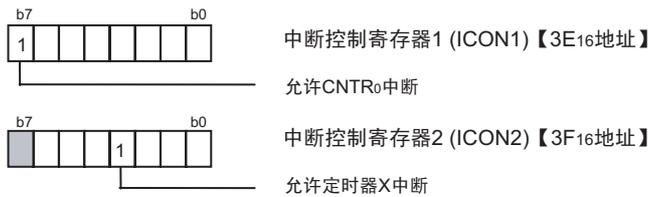
- 给预定标器X和定时器X设定初始值。



步骤6: 为了不执行不必要的中断处理, 必须将定时器X中断请求位和CNTR₀中断请求位置“0”(无请求)



步骤7: 在使用中断时, 必须将使用中断的中断允许位置“1”(允许中断)



步骤8: 开始定时器X的计数

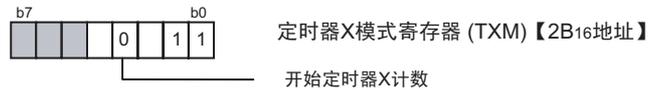


图 2 定时器 X 脉冲宽度测定模式的设定方法 (2)

2. 应用例子的说明

■要点

对输入到P14/CNTR0管脚的脉冲的“H”电平宽度进行计数。

■说明

对输入到P14/CNTR0管脚的FG脉冲的“H”电平宽度进行计数。由定时器X中断检测下溢，由CNTR0中断检测输入脉冲的“H”电平的结束。

运行时钟使用 $f(XIN)=4.19\text{MHz}$ 高速模式。

■例

当 $f(XIN)=4.19\text{MHz}$ 时，以16分频后的 $3.8\mu\text{s}$ 为计数源。在 $\text{FFFF}_{16}\sim\text{0000}_{16}$ 的范围内可测定到250ms。

2.1 定时器的连接和分频比的设定

定时器的连接和分频比的设定如图3所示。

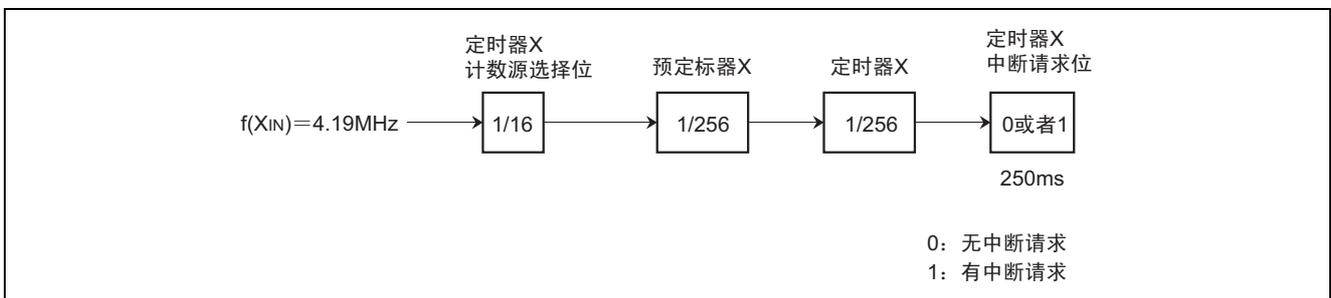


图 3 定时器的连接和分频比的设定

2.2 控制步骤例子

控制步骤例子如图4所示。

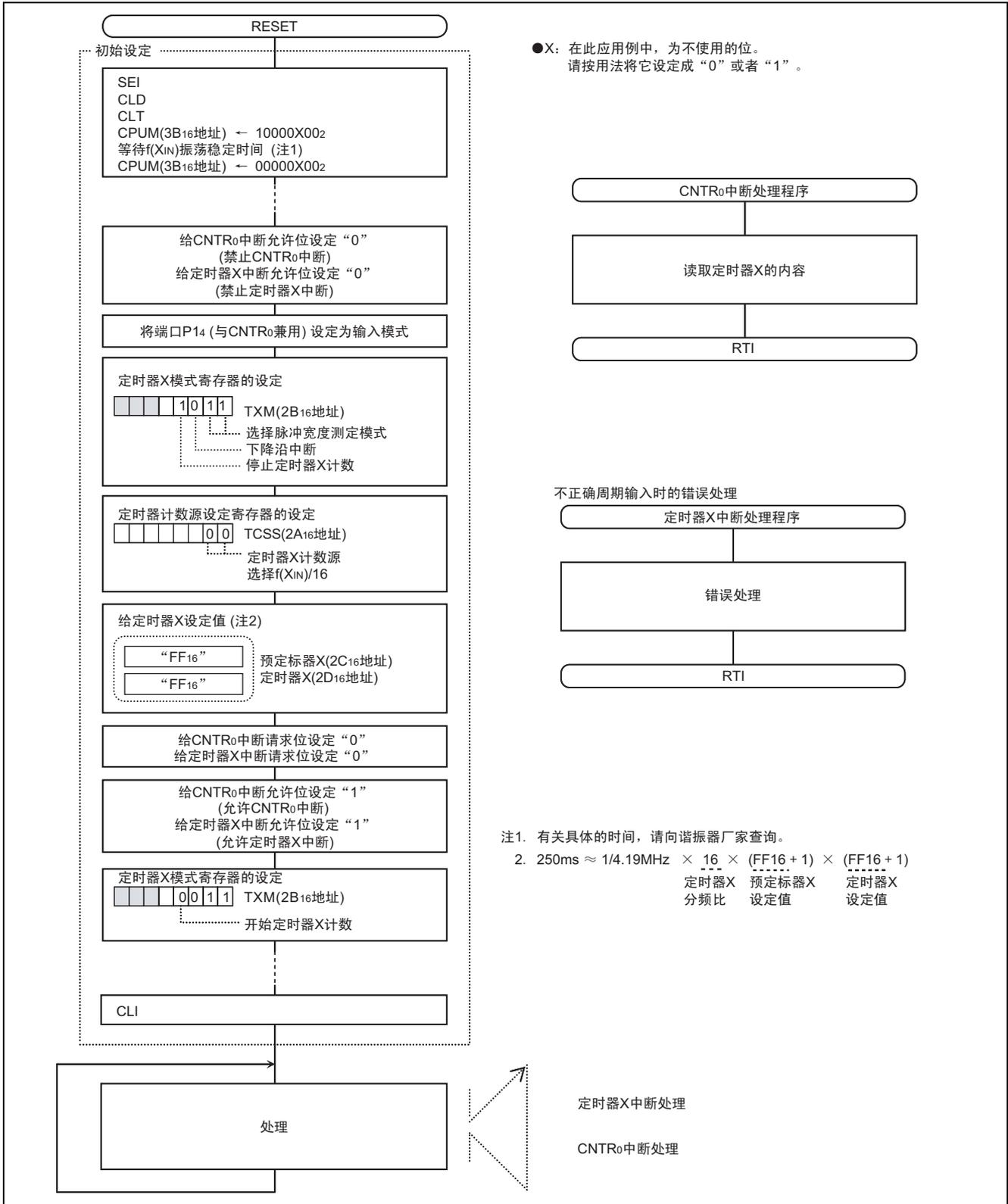


图 4 控制步骤例子

3. 参考文献

数据表

7542群数据表（最新版本请从瑞萨科技网页取得）

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修订记录

Rev.	发行日	修订内容	
		页	修订处
1.00	2004.09.15	—	初版发行

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